



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wagner, Sigurd

Serial No.: 09/647,193

Filed: 07/03/01

Title: METHOD FOR MAKING MULTI-LAYER ELECTRONICS

411/a
9/26/02
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Examiner: Estrada, M.

Group Art Unit: 2823

Commissioner of Patents and Trademarks
Washington, D.C. 20231

RESPONSE

Sir:

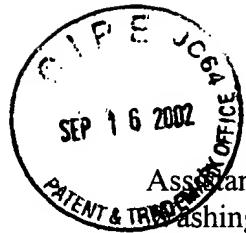
This is a response to the outstanding Office Action dated July 18, 2002, on the above-identified invention. The time period for response extends to and includes October 18, 2002.

AMENDMENT

In the claims

Please amend the claims as follows:

Sub 3
10. (Amended) The process of claim 1 wherein the thin film active electronics are produced continuously on separate carrier substrates.



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Assistant Commissioner for Patents
Washington, D.C. 20231

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Re: Our file: 7616/16/1 Examiner: Estrada, M.
Applicant: Sigurd Wagner Group Art Unit: 2823
Serial No.: 09/647,193
Filing Date: 07/03/01
Title: Method for Making Multilayer Thin-Film Electronics

Sir:

Enclosed for filing in the United States Patent and Trademark Office is the following:

1. Response to Office Action
2. Transmittal Sheet
3. Postcard Receipt

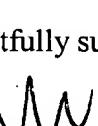
CONDITIONAL PETITION

If any extension of time is required for the submission of the above-identified items, Applicant requests that this be considered a petition therefor. Please charge any additional charges or any other charges relating to this matter to deposit account of the writer, **Account No. 06-2143**. A duplicate copy of this letter is enclosed.

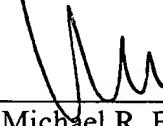
9/10/02
Date

enc.

Respectfully submitted,


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I hereby certify that this correspondence is being deposited with the United States Postal Service, First Class Mail, postage prepaid, to the Assistant Commissioner for Patents, Washington, D.C. 20231 on 9/10/02.

By: 

Michael R. Friscia